### General purpose (dual digital transistor)

#### <For DTr1(NPN)>

| Parameter            | Value |
|----------------------|-------|
| V <sub>CC</sub>      | 50V   |
| I <sub>C(MAX.)</sub> | 100mA |
| R <sub>1</sub>       | 4.7kΩ |
| R <sub>2</sub>       | 47kΩ  |

#### <For DTr2(PNP)>

| ,                    |        |  |  |  |  |
|----------------------|--------|--|--|--|--|
| Parameter            | Value  |  |  |  |  |
| V <sub>CC</sub>      | -50V   |  |  |  |  |
| I <sub>C(MAX.)</sub> | -100mA |  |  |  |  |
| R <sub>1</sub>       | 4.7kΩ  |  |  |  |  |
| R <sub>2</sub>       | 47kΩ   |  |  |  |  |

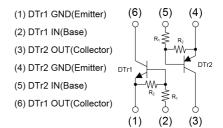
#### Features

- 1)Both the DTA143Z chip and DTC143Z chip in a EMT or UMT package.
- 2)Mounting possible with EMT3 or UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half.

#### Outline

| SOT-563     | SOT-363     |
|-------------|-------------|
| (1) (2) (3) | (1) (2) (3) |
| EMD22       | UMD22N      |
| (EMT6)      | (UMT6)      |

#### •Inner circuit



## Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

| - r dertagnig epermedations |                   |                 |                |                   |                 |                                 |         |
|-----------------------------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| Part No.                    | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width (mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
| EMD22                       | SOT-563<br>(EMT6) | 1616            | T2R            | 180               | 8               | 8000                            | D22     |
| UMD22N                      | SOT-363<br>(UMT6) | 2021            | TR             | 180               | 8               | 3000                            | D22     |

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

| Parameter                    |               |                     | DTr1(NPN) | DTr2(PNP) | Unit     |
|------------------------------|---------------|---------------------|-----------|-----------|----------|
| Supply voltage               |               |                     | 50        | -50       | V        |
| Input voltage                |               |                     | -5 to 30  | -30 to 5  | V        |
| Output current               |               |                     | 100       | -100      | mA       |
| Collector current            |               |                     | 100       | -100      | mA       |
| Power dissipation            | EMD22/ UMD22N | P <sub>D</sub> *2*3 | 1:        | 50        | mW/Total |
| Junction temperature         |               |                     | 1         | 50        | °C       |
| Range of storage temperature |               |                     | -55 to    | +150      | °C       |

## • Electrical characteristics ( $T_a = 25$ °C) < For DTr1(NPN)>

| Parameter            | Cumbal                         | Conditions                                  | Values |      |      | Unit  |
|----------------------|--------------------------------|---|--------|------|------|-------|
| Parameter            | Symbol                         | Conditions                                  | Min.   | Тур. | Max. | Offit |
| Input voltage        | $V_{I(off)}$                   | $V_{CC} = 5V, I_{O} = 100 \mu A$            | -      | -    | 0.5  | V     |
| Input voltage        | V <sub>I(on)</sub>             | $V_O = 0.3V$ , $I_O = 5mA$                  | 1.3    | 1    | -    | V     |
| Output voltage       | V <sub>O(on)</sub>             | $I_O = 5mA$ , $I_I = 250\mu A$              | -      | 100  | 300  | mV    |
| Input current        | I <sub>I</sub>                 | V <sub>I</sub> = 5V                         | -      | -    | 1.8  | mA    |
| Output current       | I <sub>O(off)</sub>            | V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V  | -      | -    | 500  | nA    |
| DC current gain      | Gı                             | $V_{O} = 5V, I_{O} = 10mA$                  | 80     | -    | -    | -     |
| Input resistance     | R <sub>1</sub>                 | -   | 3.29   | 4.7  | 6.11 | kΩ    |
| Resistance ratio     | R <sub>2</sub> /R <sub>1</sub> | -   | 8      | 10   | 12   | -     |
| Transition frequency | f <sub>T</sub> *1              | $V_{CE} = 10V, I_{E} = -5mA,$<br>f = 100MHz | -      | 250  | -    | MHz   |

# ● Electrical characteristics (T<sub>a</sub> = 25°C) <For DTr2(PNP)>

| Dorameter            | Cumbal                         | Conditions  | Values |      |      | Unit  |  |
|----------------------|--------------------------------|---|--------|------|------|-------|--|
| Parameter            | Symbol                         | Conditions  | Min.   | Тур. | Max. | Offic |  |
| lamut valtaga        | $V_{I(off)}$                   | $V_{CC} = -5V, I_{O} = -100 \mu A$                          | -      | -    | -0.5 | V     |  |
| Input voltage        | V <sub>I(on)</sub>             | $V_O = -0.3V$ , $I_O = -5mA$                                | -1.3   | -    | -    | V     |  |
| Output voltage       | V <sub>O(on)</sub>             | $I_O = -5 \text{mA}, I_I = -250 \mu \text{A}$               | -      | -100 | -300 | mV    |  |
| Input current        | I <sub>I</sub>                 | V <sub>I</sub> = -5V  | -      | -    | -1.8 | mA    |  |
| Output current       | I <sub>O(off)</sub>            | V <sub>CC</sub> = -50V, V <sub>I</sub> = 0V                 | -      | -    | -500 | nA    |  |
| DC current gain      | Gı                             | $V_O = -5V$ , $I_O = -10mA$                                 | 80     | -    | -    | -     |  |
| Input resistance     | R <sub>1</sub>                 | -   | 3.29   | 4.7  | 6.11 | kΩ    |  |
| Resistance ratio     | R <sub>2</sub> /R <sub>1</sub> | -   | 8      | 10   | 12   | -     |  |
| Transition frequency | f <sub>T</sub> *1              | V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA,<br>f = 100MHz | -      | 250  | -    | MHz   |  |

<sup>\*1</sup> Characteristics of built-in transistor.



<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

INPUT VOLTAGE: V<sub>(on)</sub> [V]

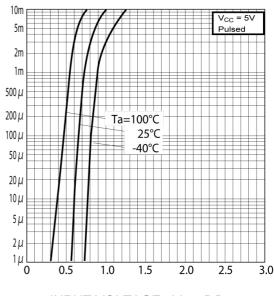
## ● Electrical characteristic curves(T<sub>a</sub> = 25°C) < For DTR1(NPN)>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

100  $V_0 = 0.3V$ 50 Pulsed 20 10 5 Ta= -40°C 25°C 2 100°C 500m 200m 100m L 200 μ 500 μ 1m 10m 20m 50m 100m OUTPUT CURRENT : Io [A]

OUTPUT CURRENT : Io [A]

Fig.2 Output Current vs. Input Voltage (OFF Characteristics)



INPUT VOLTAGE :  $V_{I(off)}$  [V]

Fig.3 Output Current vs. Output Voltage

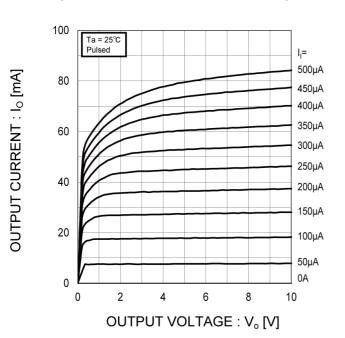
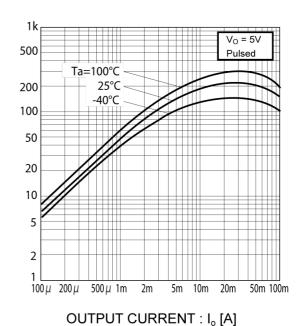


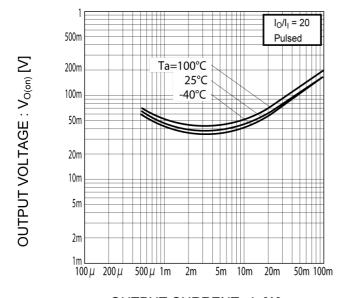
Fig.4 DC Current Gain vs. Output Current



OC CURRENT GAIN: G

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C) < For DTR1(NPN)>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT : Io [A]

## ● Electrical characteristic curves(T<sub>a</sub>=25°C) < For DTr2(PNP)>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

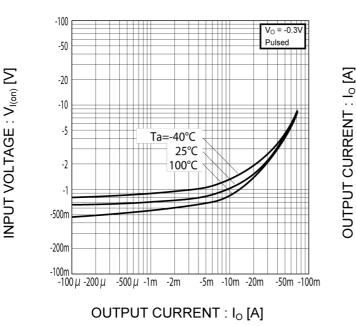


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

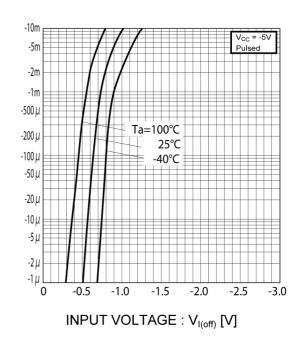


Fig.3 Output Current vs. Output Voltage

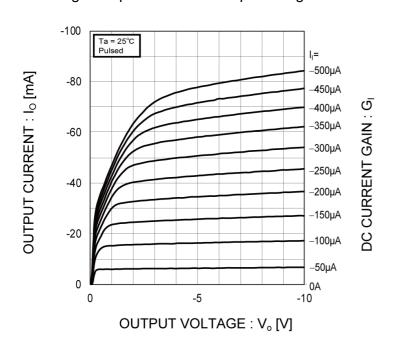
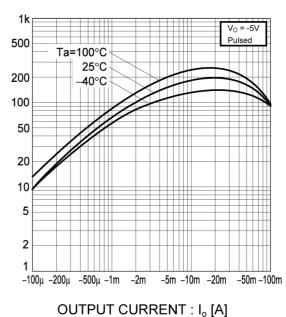
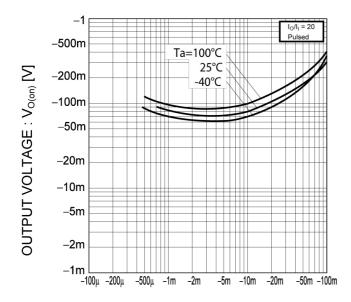


Fig.4 DC Current Gain vs. Output Current



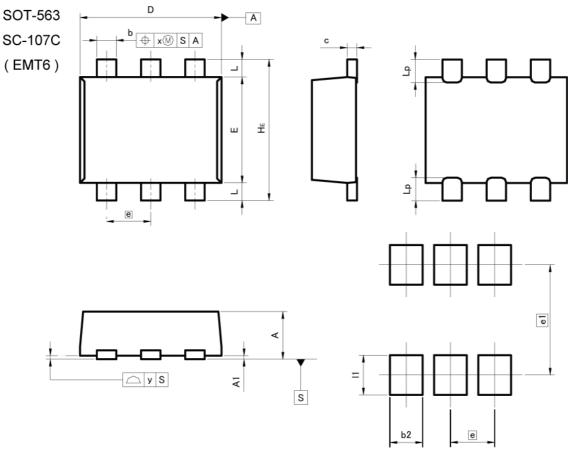
## ● Electrical characteristic curves(T<sub>a</sub>=25°C) < For DTr2(PNP)>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT :  $I_o$  [A]

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

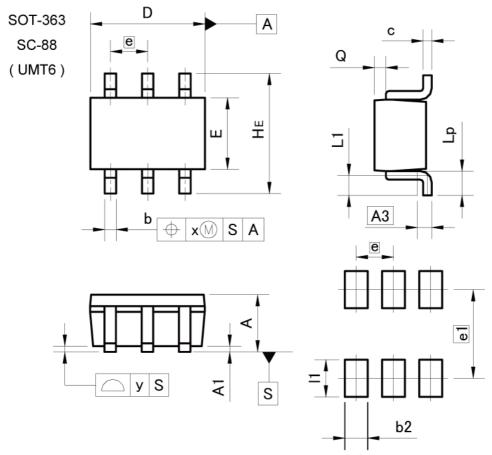
| DIM | MILIM | MILIMETERS |       | HES   |  |
|-----|-------|------------|-------|-------|--|
| DIM | MIN   | MAX        | MIN   | MAX   |  |
| Α   | 0.45  | 0.55       | 0.018 | 0.022 |  |
| A1  | 0.00  | 0.10       | 0.000 | 0.004 |  |
| b   | 0.17  | 0.27       | 0.007 | 0.011 |  |
| С   | 0.08  | 0.18       | 0.003 | 0.007 |  |
| D   | 1.50  | 1.70       | 0.059 | 0.067 |  |
| E   | 1.10  | 1.30       | 0.043 | 0.051 |  |
| е   | 0.9   | 50         | 0.020 |       |  |
| HE  | 1.50  | 1.70       | 0.059 | 0.067 |  |
| L   | 0.10  | 0.30       | 0.004 | 0.012 |  |
| Lp  | _     | 0.35       | -     | 0.014 |  |
| х   | _     | 0.10       | _     | 0.004 |  |
| У   | _     | 0.10       | -     | 0.004 |  |

| DIM | MILIMETERS |      | INC | HES   |  |
|-----|------------|------|-----|-------|--|
| DIM | MIN        | MAX  | MIN | MAX   |  |
| b2  | _          | 0.37 | _   | 0.015 |  |
| e1  | 1.25       |      | 0.0 | 49    |  |
| 11  | -          | 0.45 | -   | 0.018 |  |

Dimension in mm/inches



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INC   | HES   |
|-----|-------|-------|-------|-------|
| DIM | MIN   | MAX   | MIN   | MAX   |
| Α   | 0.80  | 1.00  | 0.031 | 0.039 |
| A1  | 0.00  | 0.10  | 0.000 | 0.004 |
| A3  | 0.5   | 25    | 0.0   | 10    |
| b   | 0.15  | 0.30  | 0.006 | 0.012 |
| С   | 0.10  | 0.20  | 0.004 | 0.008 |
| D   | 1.90  | 2.10  | 0.075 | 0.083 |
| E   | 1.15  | 1.35  | 0.045 | 0.053 |
| е   | 0.0   | 65    | 0.026 |       |
| HE  | 2.00  | 2.20  | 0.079 | 0.087 |
| L1  | 0.20  | 0.50  | 0.008 | 0.020 |
| Lp  | 0.25  | 0.55  | 0.010 | 0.022 |
| Q   | 0.10  | 0.30  | 0.004 | 0.012 |
| х   | -     | 0.10  | -     | 0.004 |
| У   | -     | 0.10  | -     | 0.004 |

| DIM  | MILIM | MILIMETERS |     | HES   |
|------|-------|------------|-----|-------|
| DIM  | MIN   | MAX        | MIN | MAX   |
| b2   | - 7   | 0.40       | -   | 0.016 |
| e1   | 1.55  |            | 0.0 | 61    |
| - 11 | -     | 0.65       | -   | 0.026 |

Dimension in mm/inches



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|---------|----------|------------|-----------|
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| CLASSIV | CLASSIII | CLASSⅢ     | CLASSIII  |

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  - [h] Use of the Products in places subject to dew condensation
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